IRS2540PBF Datasheet

www.digi-electronics.com

https://www.DiGi-Electronics.com
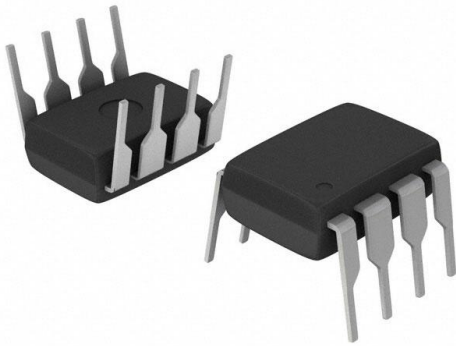
DiGi Electronics Part Number	IRS2540PBF-DG
Manufacturer	Infineon Technologies
Manufacturer Product Number	IRS2540PBF
Description	IC LED DRIVER CTRLR PWM 8DIP
Detailed Description	LED Driver IC 1 Output DC DC Controller Step-Down (Buck) PWM Dimming 8-PDIP

Purchase and inquiry

Manufacturer Product Number:	Manufacturer:
IRS2540PBF	Infineon Technologies
Series:	Product Status:
-	Obsolete
Type:	Topology:
DC DC Controller	Step-Down (Buck)
Internal Switch(s):	Number of Outputs:
No	1
Voltage - Supply (Min):	Voltage - Supply (Max):
9V	15.6V
Voltage - Output:	Current - Output / Channel:
-	-
Frequency:	Dimming:
500kHz	PWM
Applications:	Operating Temperature:
-	-25°C ~ 150°C (TJ)
Mounting Type:	Package / Case:
Through Hole	8-DIP (0.300", 7.62mm)
Supplier Device Package:	Base Product Number:
8-PDIP	IRS2540

Environmental & Export classification

Moisture Sensitivity Level (MSL):	REACH Status:
1 (Unlimited)	REACH Unaffected
ECCN:	HTSUS:
EAR99	8542.39.0001

Data Sheet No. PD60293

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Not recommended for new design

IRS254(0,1)(S)PbF

LED BUCK REGULATOR CONTROL IC

Description

The IRS254(0,1) are high voltage, high frequency buck control ICs for constant LED current regulation. They incorporate a continuous mode time-delayed hysteretic buck regulator to directly control the average load current, using an accurate on-chip bandgap voltage reference.

The application is inherently protected against short circuit conditions, with the ability to easily add open-circuit protection. An external high-side bootstrap circuit drives the buck switching element at high frequencies. A low-side driver is also provided for synchronous rectifier designs. All functions are realized within a simple 8 pin DIP or SOIC package.

Features

- 200 V (IRS2540) and 600 V (IRS2541) half bridge driver
- Micropower startup (<500 μA)
- ±2% voltage reference
- 140 ns deadtime
- 15.6 V zener clamp on V_{CC}
- Frequency up to 500 kHz
- Auto restart, non-latched shutdown
- PWM dimmable
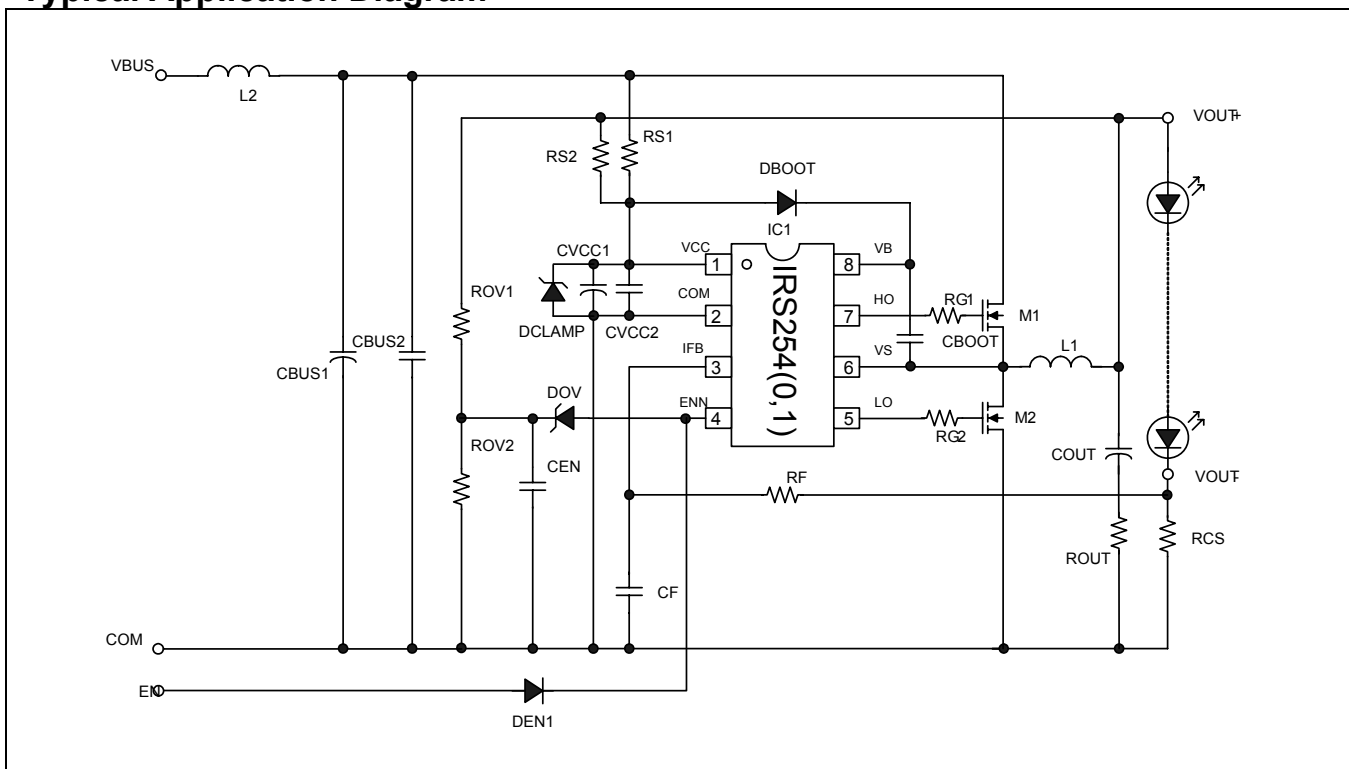- Small 8-Lead DIP/8-Lead SOIC packages

Packages
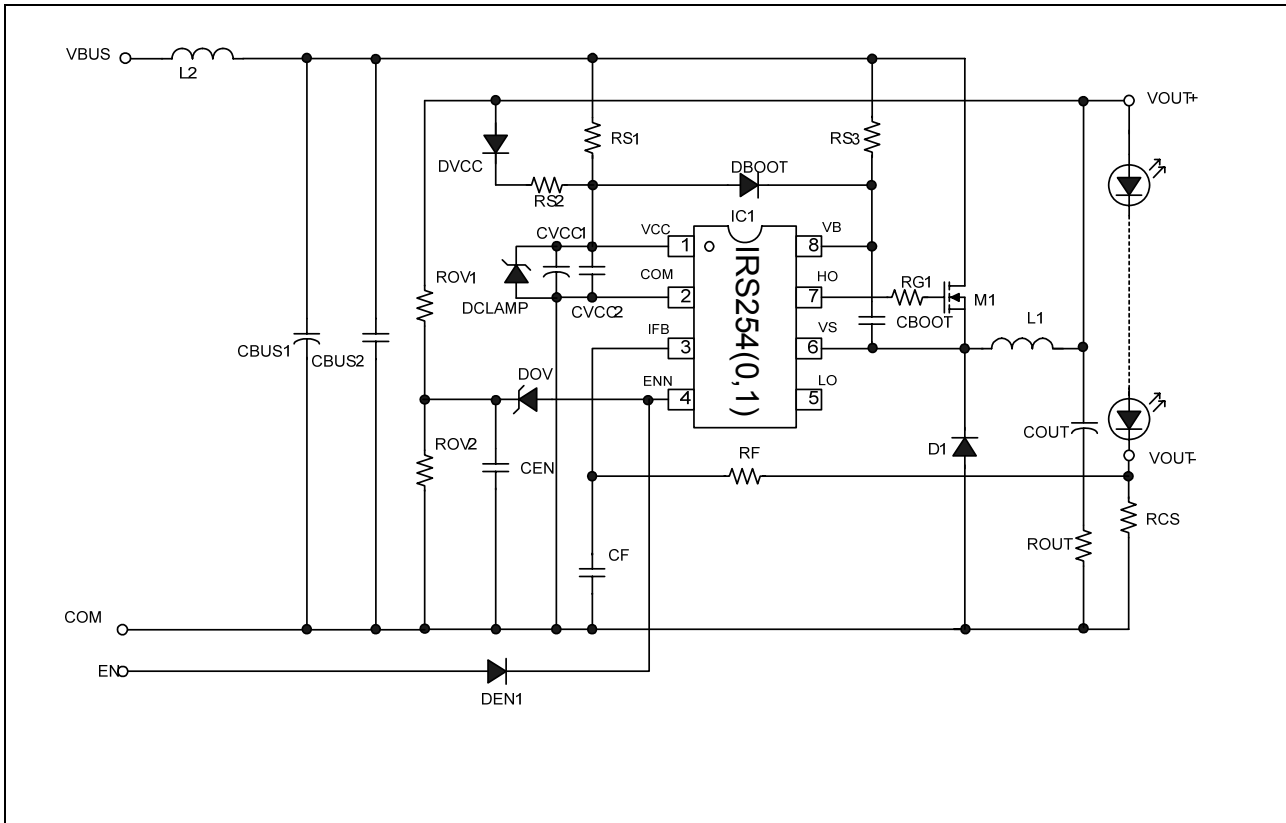

8-Lead PDIP
IRS254(0,1)PbF

8-LeadSOIC
IRS254(0,1)SPbF

Typical Application Diagram

IRS254(0,1)(S)PbF

Alternate application circuit using a single MOSFET

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Absolute Maximum Ratings

Absolute maximum ratings indicate sustained limits beyond which damage to the device may occur. All voltage parameters are absolute voltages referenced to COM, all currents are defined positive into any lead. The thermal resistance and power dissipation ratings are measured under board mounted and still air conditions.

Symbol	Definition		Min.	Max.	Units
V_B	High-side floating supply voltage	IRS2540	-0.3	225	V
		IRS2541	-0.3	625	
V_S	High-side floating supply offset voltage		$V_B - 25$	$V_B + 0.3$	
V_{HO}	High-side floating output voltage		$V_S - 0.3$	$V_B + 0.3$	
V_{LO}	Low-side output voltage		-0.3	$V_{CC} + 0.3$	
V_{IFB}	Feedback voltage		-0.3	$V_{CC} + 0.3$	
V_{ENN}	Enable voltage		-0.3	$V_{CC} + 0.3$	
I_{CC}	Supply current (Note 1)		-20	20	mA
dV/dt	Allowable offset voltage slew rate		-50	50	V/ns
P_D	Package power dissipation @ $T_A \leq$ +25 ºC $P_D = (T_{JMAX}-T_A)/R_{THJA}$	(8-Pin DIP)	---	1	W
		(8-Pin SOIC)	---	0.625	
R_{THJA}	Thermal resistance, junction to ambient	(8-Pin DIP)	---	125	ºC/W
		(8-Pin SOIC)	---	200	
T_J	Junction temperature		-55	150	ºC
T_S	Storage temperature		-55	150	
T_L	Lead temperature (soldering, 10 seconds)		---	300	

Note 1: This IC contains a zener clamp structure between the chip V_{CC} and COM, with a nominal breakdown voltage of 15.6 V. Please note that this supply pin should not be driven by a low impedance DC power source greater than V_{CLAMP} specified in the electrical characteristics section.

Recommended Operating Conditions

For proper operation the device should be used within recommended conditions.

Symbol	Definition		Min.	Max.	Units
V_{BS}	High side floating supply voltage		$V_{CC} - 0.7$	V_{CLAMP}	V
V_S	Steady state high-side floating supply offset voltage	IRS2540	-1	200	
		IRS2541	-1	600	
V_{CC}	Supply voltage		V_{CCUV+}	V_{CLAMP}	
I_{CC}	Supply current		Note 2	10	mA
T_J	Junction temperature		-25	125	ºC

Note 2: Sufficient current should be supplied to V_{CC} to keep the internal 15.6 V zener regulating at V_{CLAMP}.

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IRS254(0,1)(S)PbF

Electrical Characteristics

$V_{CC} = V_{BS} = V_{BIAS} = 14$ V +/- 0.25 V, $C_{LO}=C_{HO}$=1000 pF, $C_{VCC}=C_{VBS}$=0.1 µF, T_A=25 °C unless otherwise specified.

Symbol	Definition	Min	Typ	Max	Units	Test Conditions
Supply Characteristics						
V_{CCUV+}	V_{CC} supply undervoltage positive going threshold	8.0	9.0	10.0		V_{CC} rising from 0 V
V_{CCUV-}	V_{CC} supply undervoltage negative going threshold	6.5	7.5	8.5	V	V_{CC} falling from 14 V
V_{UVHYS}	V_{CC} supply undervoltage lockout hysteresis	1.0	1.2	2.0		
I_{QCCUV}	UVLO mode quiescent current	---	50	150	µA	V_{CC}=6 V
I_{QCCENN}	Diesabled mode quiescent current	---	1.0	2.0		EN>V_{ENTH+}
I_{QCC}	Quiescent V_{CC} supply current	---	1.0	2.0	mA	I_{FB} = 1 V
I_{CC50k}	V_{CC} supply current, f = 50 kHz	---	2.0	3.0		Duty Cycle = 50% f = 50 kHz
V_{CLAMP}	V_{CC} zener clamp voltage	14.6	15.6	16.6	V	I_{CC} = 10 mA
Floating Supply Characteristics						
I_{QBS0}	Quiescent V_{BS} supply current	---	1.0	2.0	mA	$V_{HO} = V_S$
I_{QBS1}	Quiescent V_{BS} supply current	---	2.0	3.0		I_{FB} = 0 V
V_{BSUV+}	V_{BS} supply undervoltage positive going threshold	6.5	7.5	8.5	V	
V_{BSUV-}	V_{BS} supply undervoltage negative going threshold	6.0	7.0	8.0		
I_{LK}	Offset supply leakage current	---	1	50	µA	IRS2540:$V_B=V_S$=200 V IRS2541:$V_B=V_S$=600 V
Current Control Operation						
V_{ENNTH+}	ENN pin positive threshold	2.5	2.7	3.0	V	
V_{ENNTH-}	ENN pin negative threshold	1.7	2.0	2.3		
$V_{0.5}$	0.5 V voltage reference (die level test)	490	500	510	mV	
V_{IFBTH}	IFB pin threshold	455	500	540		
f	Maximum frequency	---	500	---	kHz	
Gate Driver Output Characteristics						
V_{OL}	Low level output voltage (HO or LO)	---	COM	---	V	
V_{HL}	High level output voltage (HO or LO)	---	V_{CC}	---		
t_r	Turn-on rise time	---	50	120	ns	
t_f	Turn-off fall time	---	30	50		
$I_{O+/-}$	Output source/sink short circuit pulsed current	---	0.5/0.7	---	A	
DT	Deadtime	---	140	---		
$t_{LO,ON}$	Delay between V_{IFB}>V_{IFBTH} and LO turn-on	---	320	---	ns	I_{FB} = 50 kHz square wave, 200 mV pk-pk DC offset = 400 mV Duty Cycle = 50%
$t_{LO,OFF}$	Delay between V_{IFB}<V_{IFBTH} and LO turn-off	---	180	---		
$t_{HO,ON}$	Delay between V_{IFB}<V_{IFBTH} and HO turn-on	---	320	---		
$t_{HO,OFF}$	Delay between V_{IFB}>V_{IFBTH} and HO turn-off	---	180	---		

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IRS254(0,1)(S)PbF

Electrical Characteristics

V_{CC} = V_{BS} = V_{BIAS} = 14 V +/- 0.25 V, C_{LO}=C_{HO}=1000 pF, C_{VCC}=C_{VBS}=0.1 µF, T_A=25 °C unless otherwise specified.

Symbol	Definition	Min	Typ	Max	Units	Test Conditions
Watchdog timer						
t_{WD}	Watchdog timer period	---	20	---	µs	I_{FB} =1 V
P_{WWD}	LO pulse width	---	1.0	---		

Functional Block Diagram
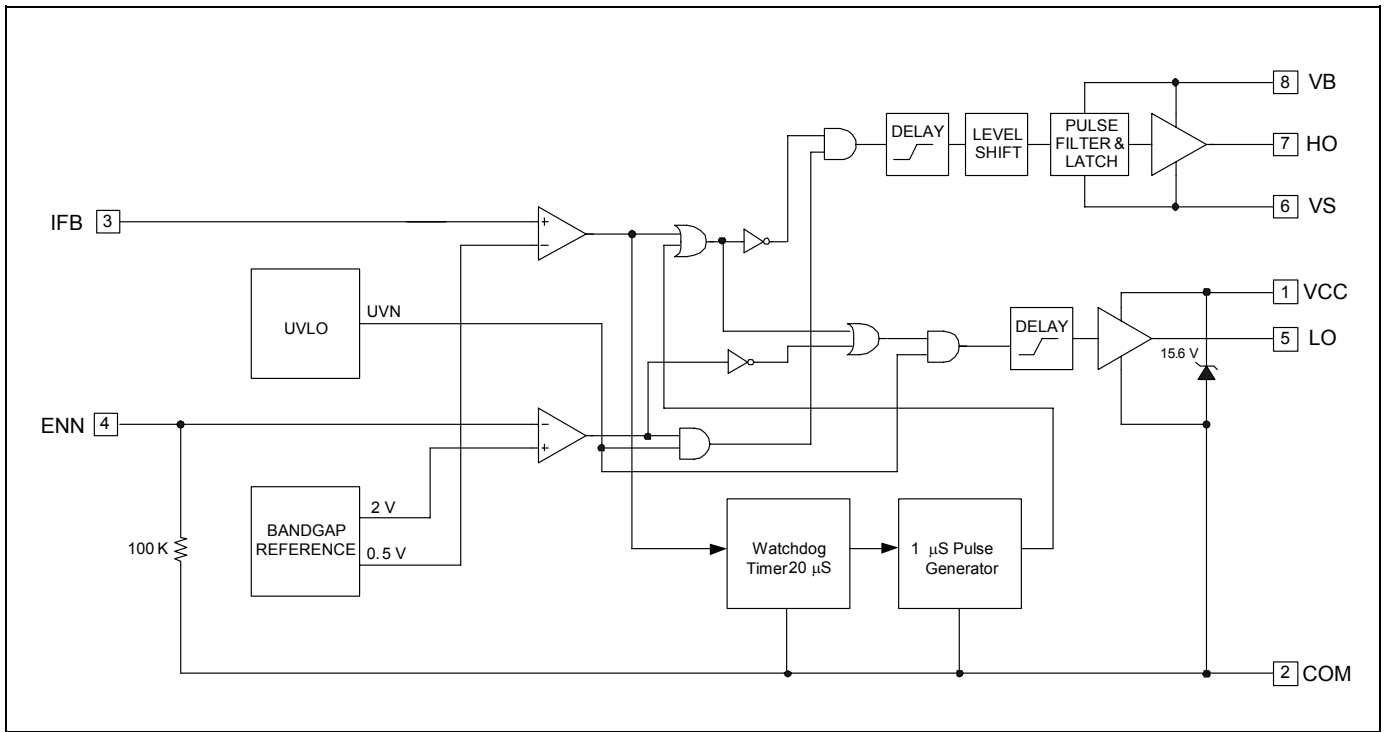
Values in block diagram are typical values

Lead Assignment

Pin Assignments	Pin #	Symbol	Description
VCC [1] ○ IRS254(0,1) [8] VB	1	VCC	Supply voltage
COM [2] [7] HO	2	COM	IC power & signal ground
IFB [3] [6] VS	3	IFB	Current feedback
ENN [4] [5] LO	4	ENN	Disable outputs (LO=High, HO=Low)
	5	LO	Low-side gate driver output
	6	VS	High-side floating return
	7	HO	High-side gate driver output
	8	VB	High-side gate driver floating supply

STATE DIAGRAM

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                    ┌─────────────────┐
                    │     POWER       │
                    │   TURN-ON       │
                    └────────┬────────┘
                             │
                             ▼
                    ┌─────────────────┐
                    │      UVLO       │
                    │  LO and HO Low  │
                    │  IQCC<IQCCUV    │
                    └────────┬────────┘
                             │
                        VCC>VCCUV+
                             │
                             ▼
 VCC<VCCUV-        ┌─────────────────┐   WDT>T_WD    ┌──────────────────┐
◄─────────────────┤ ENERGY STORING  ├──────────────►│ WATCHDOG PULSE   │
                  │     PHASE       │                │     MODE         │
                  │ HO=high, LO=low │◄───────────────┤ HO=low, LO=High  │
                  │  IFB Increasing │  Pulse>PW_WD   │ Start Pulse Timer│
                  │Start Watchdog   │                └──────────────────┘
                  │     Timer       │
                  └────────┬────────┘
    IFB<IFBTH AND      IFB>IFBTH OR
    VENN<VENNTH-       VENN>VENNTH+
                           │
                           ▼
                  ┌─────────────────┐
 VCC<VCCUV-       │ ENERGY TRANSFER │   ENN>VENNTH+
◄─────────────────┤     PHASE       ├──────────────►
                  │ HO=low, LO=high │
                  │  IFB Decreasing │
                  └─────────────────┘

 ENN<VENNTH-       ┌─────────────────┐
◄──────────────────┤ DISABLED MODE   │
                   │ HO=low, LO=high │
 VCC<VCCUV-        └─────────────────┘
◄──────────────────
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IRS254(0,1)(S)PbF
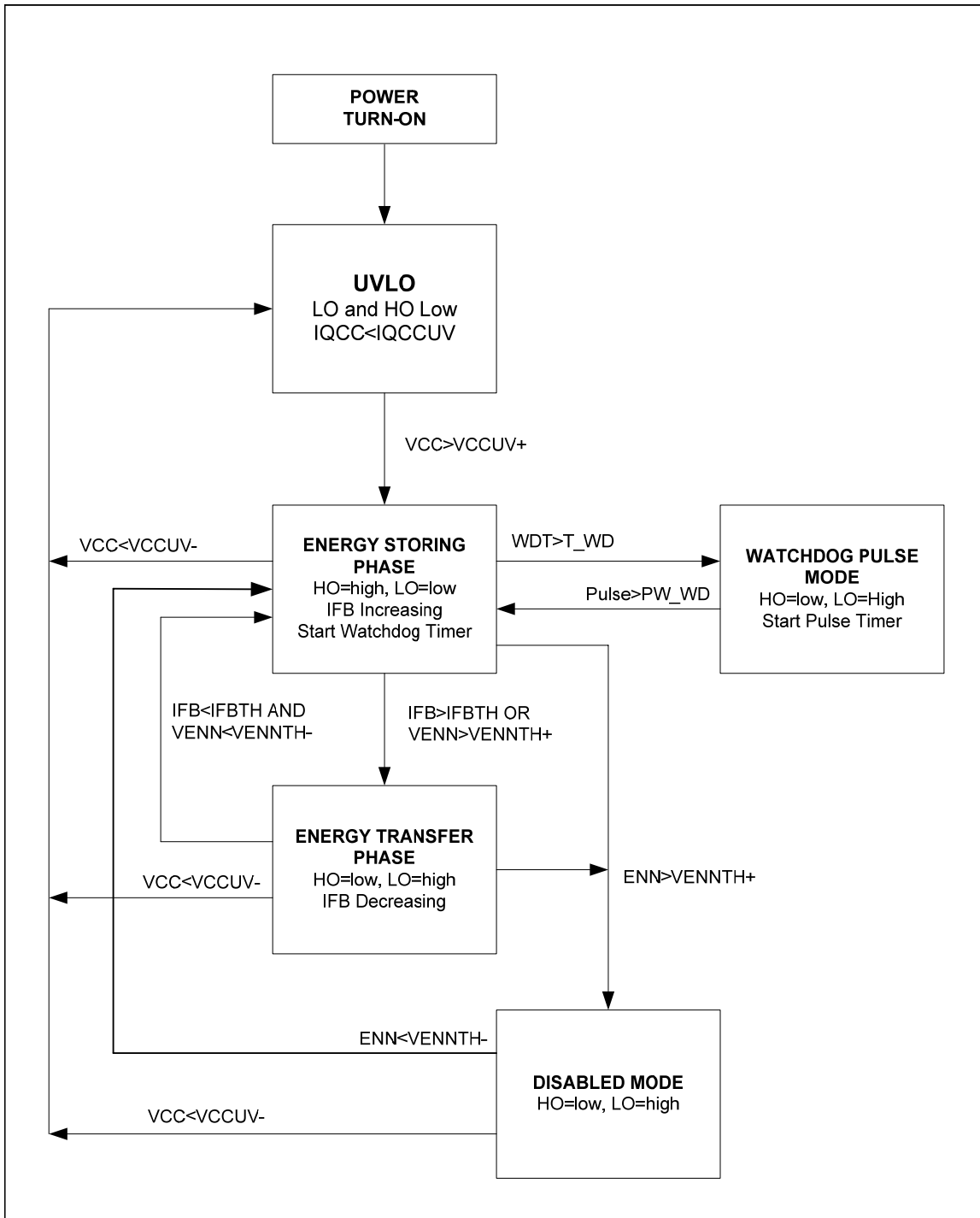
Functional Description

Operating Mode

The IRS254(0,1) operates as a time-delayed hysteritic buck controller. During normal operating conditions the output current is regulated via the IFB pin voltage (nominal value of 500 mV). This feedback is compared to an internal high precision bandgap voltage reference. An on-board dV/dt filter has also been used to ignore erroneous transitioning.

Once the supply to the IC reaches V_{CCUV+}, the LO output is held high and the HO output low for a predetermined period of time. This initiates charging of the bootstrap capacitor, establishing the V_{BS} floating supply for the high-side output. The IC then begins toggling HO and LO outputs as needed to regulate the current.
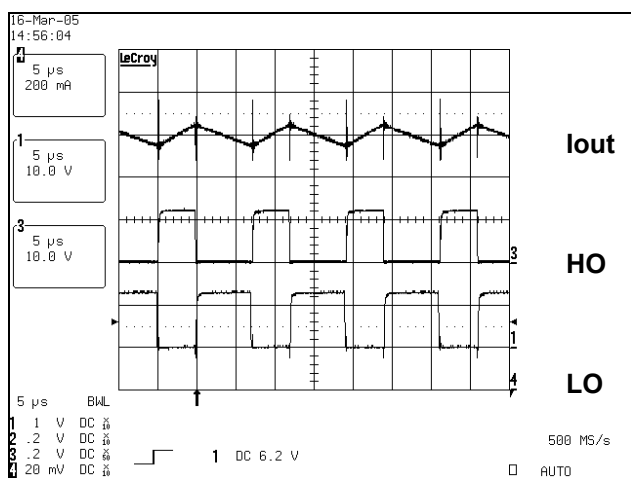
Fig.1 IRS254(0,1) Control Signals, Iavg=1.2 A

As long as V_{IFB} is below V_{IFBTH}, HO is on, modulated by the watchdog timer described below, the load is receiving current from V_{BUS}, which simultaneously stores energy in the inductor, as V_{IFB} increases, unless the load is open. Once V_{IFB} crosses V_{IFBTH}, the control loop switches HO off after the delay $t_{HO,OFF}$. Once HO is off, LO will turn on after the deadtime (DT), the inductor releases the stored energy into the load and V_{IFB} starts decreasing. When V_{IFB} crosses V_{IFBTH} again, the control loop switches HO on after the delay $t_{HO,ON}$ and LO off after the delay $t_{HO,ON}$ + DT. The switching continues to regulate the current at an average value determined as follows. When the inductance value

is large enough to maintain a low ripple on I_{FB}, $I_{out,avg}$ can be calculated:
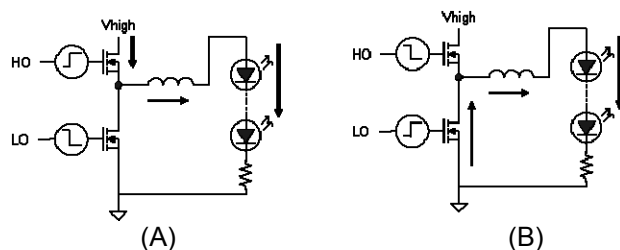
$$Iout(avg) = VIFBTH \big/ RCS$$

Fig.2 (A) Storing Energy in Inductor
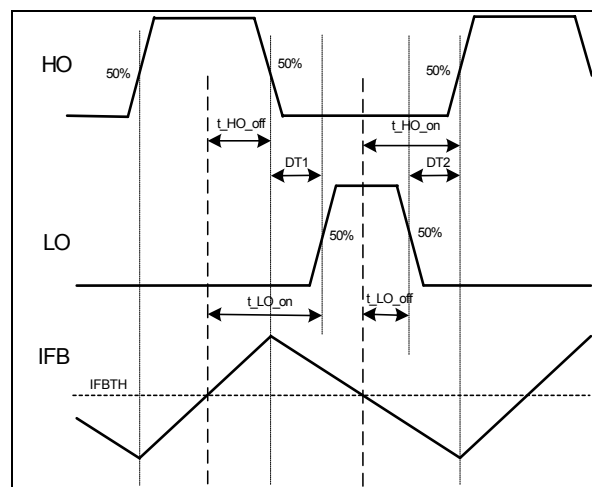(B) Releasing Inductor Stored Energy

Fig.3 IRS254(0,1) Time Delayed Hysterisis

The control method is based upon a free running frequency, in contrast to a more widely used fixed frequency regulation. This reduces the part count since there is no need for frequency setting components and also provides an inherently stable sytem, which acts as a current source.

A deadtime of approximately 140 ns between the two gate drive signals is necessary to prevent a "shoot-through" condition. At higher frequencies, the switching losses become very large in the absence of this deadtime. The deadtime has been adjusted to maintain precise current regulation, while still preventing shoot-through.

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IRS254(0,1)(S)PbF

Watchdog Timer

During an open circuit condition, without the watchdog timer, the HO output would remain high at all times and the charge stored in the bootstrap capacitor C_{BOOT} would gradually discharge the floating power supply for the high-side driver, which would then be unable to fully switch on the upper MOSFET causing high losses. To maintain sufficient charge on the bootstrap capacitor, a watchdog timer has been implemented. In the condition where V_{IFB} remains below V_{IFBTH}, the HO output will be forced low after 20 µs and the LO output forced high. This toggling of the outputs will last for approximately 1 µs to maintain and replenish sufficient charge on C_{BOOT}.
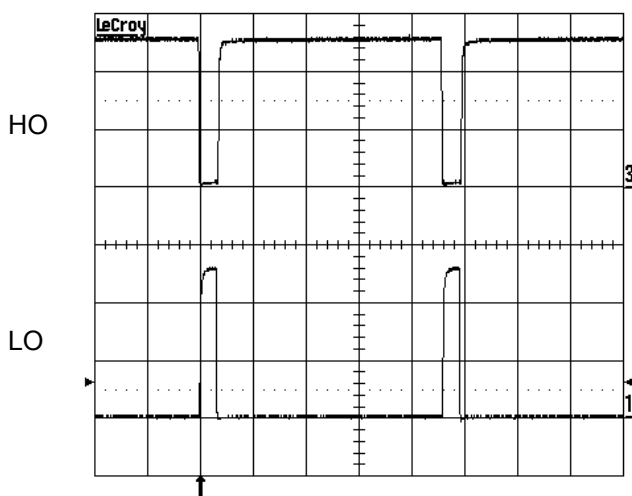
Fig.4 Illustration of Watchdog Timer

Bootstrap Capacitor and Diode

The bootstrap capacitor value needs to be chosen so that it maintains sufficient charge for at least the approximately 20 µs interval until the watchdog timer allows the capacitor to recharge. If the capacitor value is too small, the charge will dissipate in less than 20 µs. The typical bootstrap capacitor is approximately 100 nF.

The bootstrap diode should be a fast recovery or ultrafast recovery component to maintain good efficiency. Since the cathode of the bootstrap diode will be switching between zero and to the high voltage bus, the reverse recovery time of this diode is of critical importance. For additional information concerning the bootstrap components, refer to the

Design Tip (DT 98-2), *"Bootstrap Component Selection For Control ICs"* at www.irf.com under Design Support

Disable (ENN) Pin

The disable pin can be used for dimming and open-circuit protection. When the ENN pin is held low, the chip remains in a fully functional state with no alterations to the operating environment. To disable the control feedback and regulation, a voltage greater than V_{ENTH} (approximately 2.5 V) needs to be applied to the ENN pin. With the chip in a disabled state, HO output will remain low, whereas the LO output will remain high to prevent V_S from floating, in addition to maintaining charge on the bootstrap capacitor. The threshold for disabling the IRS254(0,1) has been set to 2.5 V to enhance immunity to any externally generated noise, or application ground noise. This 2.5 V threshold also makes it ideal to receive a drive signal from a local microcontroller.

Dimming Mode

To achieve dimming, a signal with constant frequency and set duty cycle can be fed into the ENN pin. There is a direct linear relationship between the average load current and duty cycle. If the ratio is 50%, 50% of the maximum set light output will be realized. Likewise if the ratio is 30%, 70% of the maximum set light output will be realized. A sufficiently high frequency of the dimming signal must be chosen to avoid flashing or "strobe light" effect. A signal on the order of a few kHz should be sufficient.

The minimum amount of dimming achievable (light output approaches 0%) will be determined by the "on" time of the HO output, when in a fully functional regulating state. To maintain reliable dimming, it is recommended to keep the "off" time of the enable signal at least 10 times that of the HO "on" time. For example, if the application is running at 75 kHz with an input voltage of 100 V and an output voltage of 20 V, the HO "on" time will be 3.3 µs (one-fourth of the period – see calculations below) according to standard buck topology theory. This will set the minimum "off" time of the enable signal to 33 µs.

$$Duty\ Cycle = \frac{V_{out}}{V_{in}} * 100 = \frac{20V}{100V} * 100 = 20\%$$
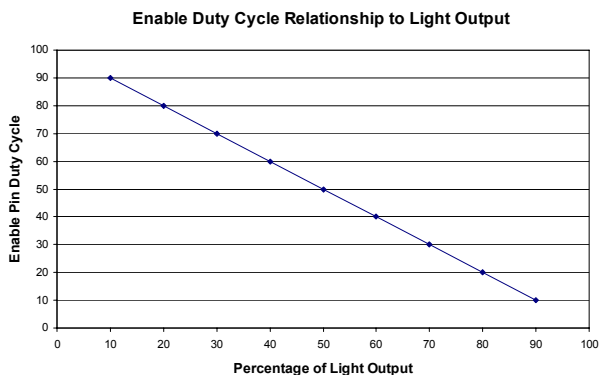
$$HO_{on\,time} = 20\% * \frac{1}{75kHz} = 3.3\mu s$$

IRS254(0,1)(S)PbF

form the voltage clamp. The repetition of the spikes can be reduced by simply increasing the capacitor size.

The two resistors form a voltage divider for the output, which is then fed into the cathode of the zener diode. The diode will only conduct, flooding the enable pin, when its nominal voltage is exceeded. The chip will enter a disabled state once the divider network produces a voltage at least 2.5 V greater than the zener rating. The capacitor serves only to filter and slow the transients/switching at the positive output terminal. The clamped output voltage can be determined by the following analysis. The choice of capacitor is at the designer's discretion.

$$V_{out} = \frac{(2.5V + DZ)(R_1 + R_2)}{R_2}$$

$DZ = $ Zener Diode Nominal Rated Voltage

Enable Duty Cycle Relationship to Light Output

Fig.5 Light Output vs Enable Pin Duty Cycle
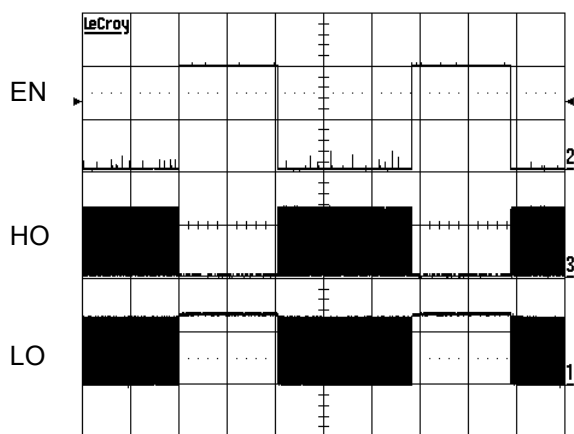
Fig.6 IRS254(0,1) Dimming Signals

Fig.8 Open Circuit Fault Signals, with Clamp

Open Circuit Protection Mode

By using the suggested voltage divider, capacitor, and zener diode, the output voltage can be clamped at any desired value. In open-circuit condition without output clamp, the positive output terminal will float at the high-side input voltage. Switching will still occur between the HO and LO outputs, whether due to the output voltage clamp or the watchdog timer. Transients and switching will be observed at the positive output terminal as seen in Fig. 8. The difference in signal shape, between the output voltage and the I_{FB}, is due to the capacitor used to
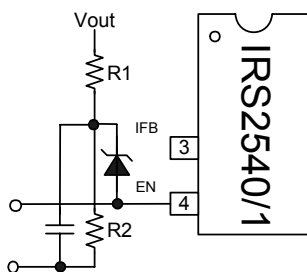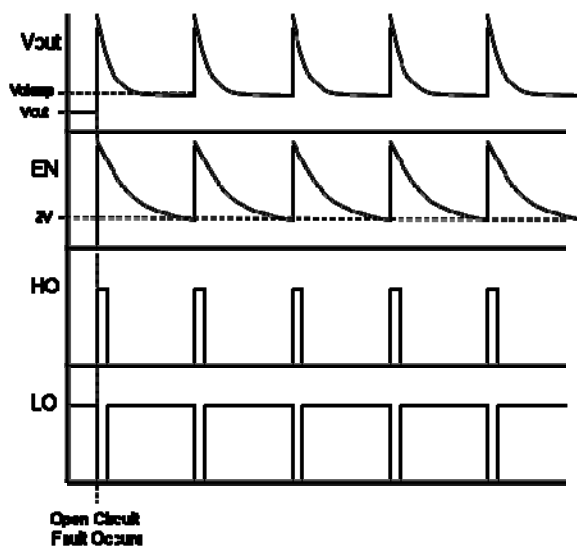

Fig.7 Open Circuit Protection Scheme

Under-voltage Lock-out Mode

The under-voltage lock-out mode (UVLO) is defined as the state IRS254(0,1) is in when V_{cc} is below the turn-on threshold of the IC. During startup conditions, if the IC supply remains below V_{CCUV+}, the IRS254(0,1) will enter the UVLO mode. This state is very similar to when the IC has been disabled via control signals, except that LO is also held low. When the supply is increased to V_{CCUV+}, the IC enters the normal operation mode. If already in normal

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operation, the IC does not enter UVLO unless the supply voltage falls below V_{CCUV--}.

Inductance Selection

To maintain tight hysteretic current regulation the inductor and output capacitor C_{OUT} (in parallel with the LEDs) need to be large enough to maintain the supply to the load during $t_{HO,ON}$ and avoid significant undershooting of the load current, which in turn causes the average current to fall below the desired value.

First, we are going to look at the effect of the inductor when there is no output capacitor to clearly demonstrate the impact of the inductor. In this case, the load current is identical to the inductor current. Fig. 9 shows how the inductor value impacts the frequency over a range of input voltages. As can be seen, the input voltage has a great impact on the frequency and the inductor value has the greatest impact at reducing the frequency for smaller input voltages.
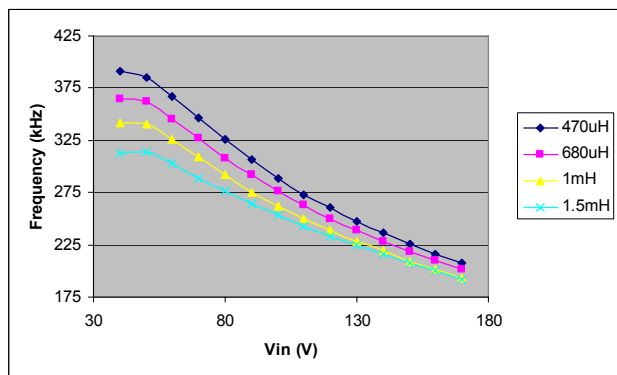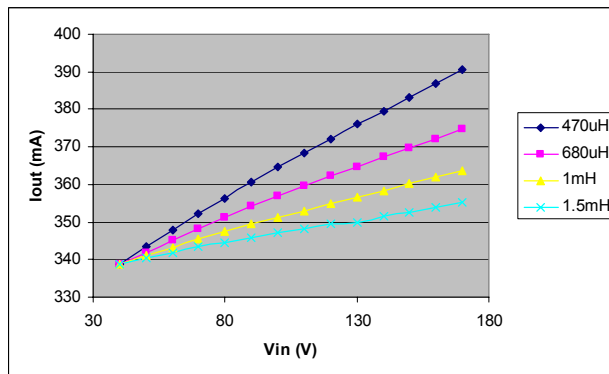

Fig.9 Frequency Response for Chosen Inductances
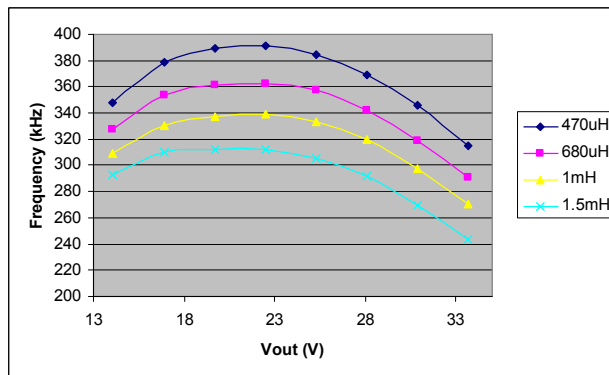**I_{out} = 350 mA, V_{out} = 16.8 V**

Fig. 10 shows how the variation in load current increases over a span of input voltages, as the inductance is decreased. Fig. 11 shows the variation of frequency over different output voltages and different inductance values. Finally Fig. 12 shows how the load current variation increases with lower inductance over a range of output voltages.

The output capacitor can be used simultaneously to achieve the target frequency and current control accuracy. Fig. 11 shows how the capacitance reduces the frequency over a range of input voltage. A small capacitance of 4.7 μF has a large effect on reducing the frequency. Fig. 12 shows how the current regulation is also improved with the output capacitance. There is a point at which continuing to

add capacitance no longer has a significant effect on the operating frequency or current regulation, as can be seen in Figs. 13 and 14.

Fig.10 Current Regulation for Chosen Inductances
I_{out} = 350 mA, V_{out} = 16.8 V

Fig.11 Frequency Response for Chosen Inductances
I_{out} = 350 mA, V_{in} = 50 V

Fig.12 Current Regulation for Chosen Inductances
I_{out} = 350 mA, V_{in} = 50 V

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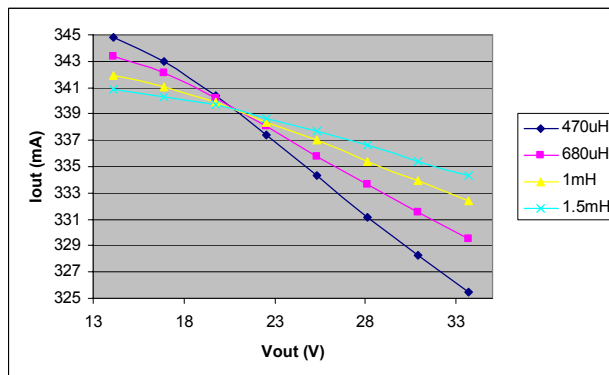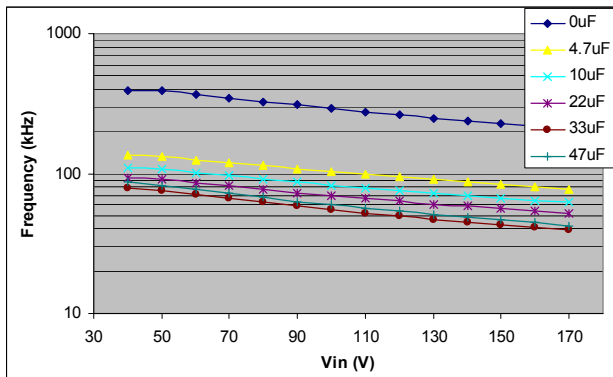
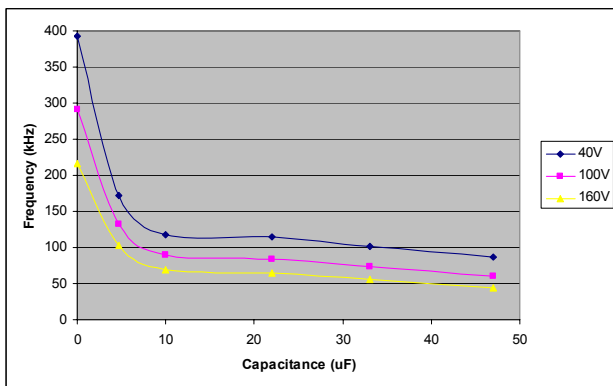**Fig. 13 I$_{out}$ = 350 mA, V$_{out}$ = 16.8 V, L = 470 µH**

Fig. 14 I $_{out}$ = 350 mA, V$_{out}$ = 16.8 V, L = 470 µH

The addition of the C$_{OUT}$ increases the amount of energy that can be stored in the output stage, which also means it can supply current for an increased period of time. Therefore by slowing down the di/dt transients in the load, the frequency is effectively decreased.

With the C$_{OUT}$ capacitor, the inductor current is no longer identical to that seen in the load. The inductor current will still have a perfectly triangular shape, where as the load will see the same basic trend in the current, but all sharp corners will be rounded with all peaks significantly reduced, as can be seen in Fig. 15

V$_{CC}$ Supply

Since the IRS245(0,1) is rated for 200 V (or 600 V), V$_{BUS}$ can reach values of this magnitude. If only a supply resistor to V$_{BUS}$ is used, it will experience extremely high power losses. For higher voltage applications an alternate V$_{CC}$ supply scheme utilizing the micro-power start-up and a resistor feed-back

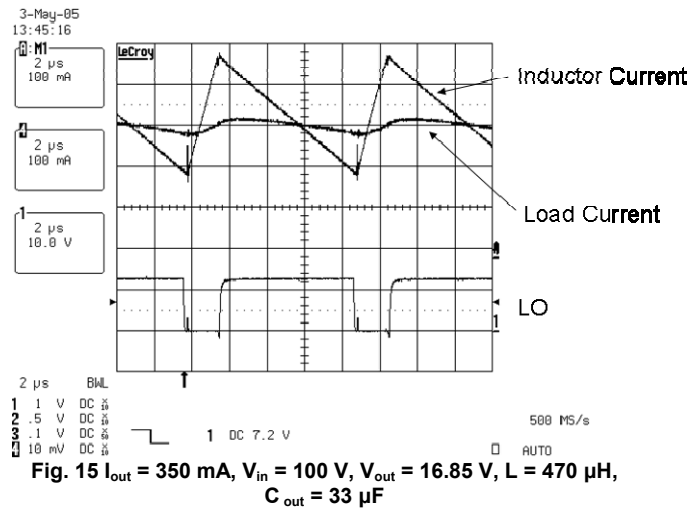from the output needs to be implemented, as seen in Fig. 16.

Fig. 15 I$_{out}$ = 350 mA, V$_{in}$ = 100 V, V$_{out}$ = 16.85 V, L = 470 µH, C $_{out}$ = 33 µF

The resistance between V$_{BUS}$ and V$_{CC}$ supply should be large enough to minimize the current sourced directly from the input voltage line; value should be on the order of hundreds of kΩ. Through the supply resistor, a current will flow to charge the V$_{CC}$ capacitor. Once the capacitor is charged up to the V$_{CCUV+}$ threshold, the IRS254(0,1) enters the micro start-up regime and begins to operate, activating the LO and HO outputs. After the first few cycles of switching, the resistor connected between the output and V$_{CC}$ will take over and source all necessary current for the IC. The resistor connecting the output to the supply should be carefully designed according to its power rating.

$$RS2 = \frac{V_{out} - 15.6V}{10mA}$$

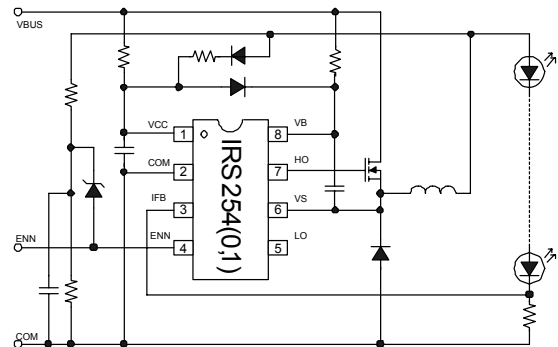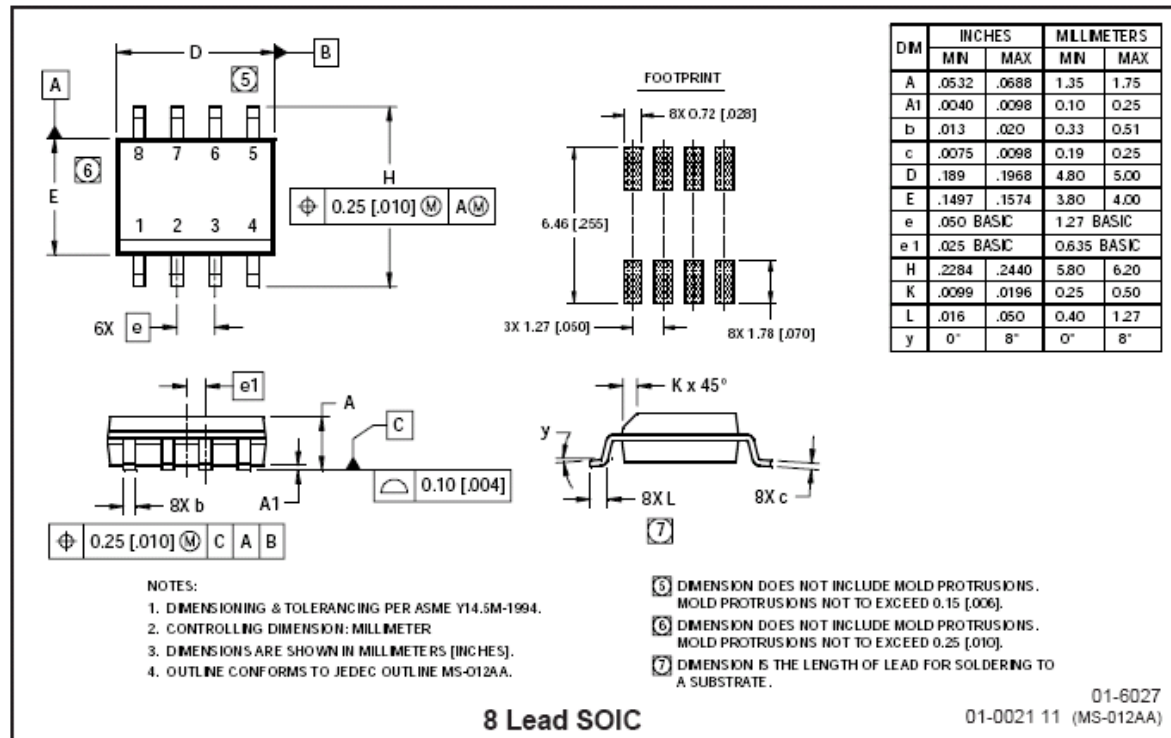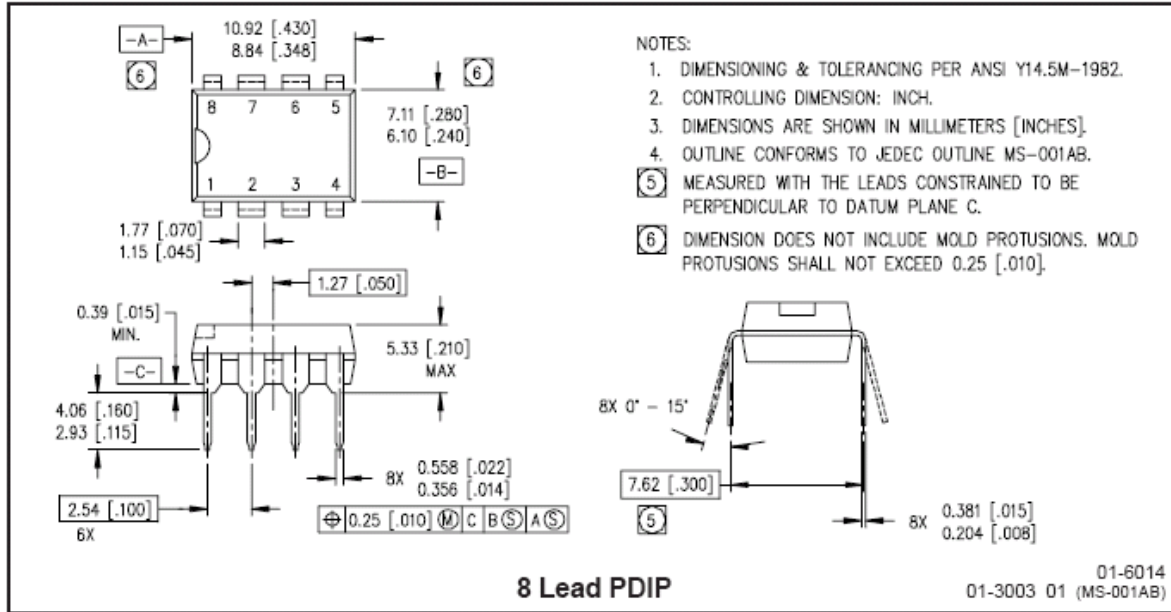$$P_{RS2} = (10mA)^2 \, RS2 \leq \frac{P_{RS2\_Rated}}{2}$$

$$Icc \approx 10mA$$

Fig. 16 Alternate Supply Diagram

International **IƆR** Rectifier

IRS254(0,1)(S)PbF

Case Outlines

NOTES:
1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M−1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS−001AB.
5. MEASURED WITH THE LEADS CONSTRAINED TO BE PERPENDICULAR TO DATUM PLANE C.
6. DIMENSION DOES NOT INCLUDE MOLD PROTUSIONS. MOLD PROTUSIONS SHALL NOT EXCEED 0.25 [.010].

8 Lead PDIP

01-6014
01-3003 01 (MS-001AB)

DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
b	.013	.020	0.33	0.51
c	.0075	.0098	0.19	0.25
D	.189	.1968	4.80	5.00
E	.1497	.1574	3.80	4.00
e	.050 BASIC		1.27 BASIC	
e 1	.025 BASIC		0.635 BASIC	
H	.2284	.2440	5.80	6.20
K	.0099	.0196	0.25	0.50
L	.016	.050	0.40	1.27
y	0°	8°	0°	8°

FOOTPRINT

NOTES:
1. DIMENSIONING & TOLERANCING PER ASME Y14.5M-1994.
2. CONTROLLING DIMENSION: MILLIMETER
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].
4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.

5. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.15 [.006].
6. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [.010].
7. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

8 Lead SOIC

01-6027
01-0021 11 (MS-012AA)

International **IΣR** Rectifier

IRS254(0,1)(S)PbF

8-Lead SOIC
Tape & Reel

LOADED TAPE FEED DIRECTION

NOTE : CONTROLLING
DIMENSION IN MM

CARRIER TAPE DIMENSION FOR 8SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	7.90	8.10	0.311	0.318
B	3.90	4.10	0.153	0.161
C	11.70	12.30	0.46	0.484
D	5.45	5.55	0.214	0.218
E	6.30	6.50	0.248	0.255
F	5.10	5.30	0.200	0.208
G	1.50	n/a	0.059	n/a
H	1.50	1.60	0.059	0.062
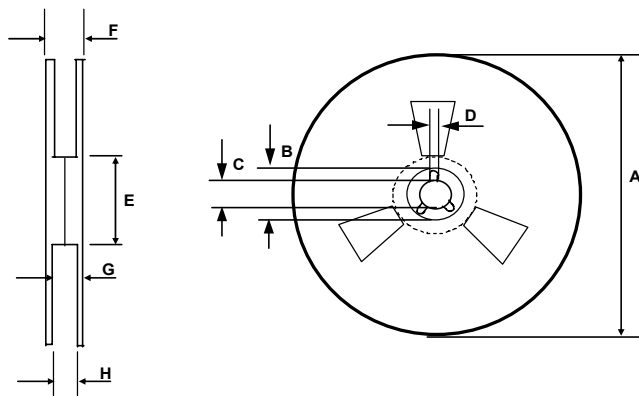
REEL DIMENSIONS FOR 8SOICN

Code	Metric		Imperial	
	Min	Max	Min	Max
A	329.60	330.25	12.976	13.001
B	20.95	21.45	0.824	0.844
C	12.80	13.20	0.503	0.519
D	1.95	2.45	0.767	0.096
E	98.00	102.00	3.858	4.015
F	n/a	18.40	n/a	0.724
G	14.50	17.10	0.570	0.673
H	12.40	14.40	0.488	0.566

International **I℞R** Rectifier

IRS254(0,1)(S)PbF

LEAD-FREE PART MARKING INFORMATION

Part number —— **IRSxxxxx**

Date code —— **YWW?**   **I℞R** —— IR logo

Pin 1 —— ●   **?XXXX** —— Lot Code
Identifier   (Prod mode – 4 digit SPN code)

?	MARKING CODE
P	Lead Free Released
	Non-Lead Free Relased

—— Assembly site code
Per SCOP 200-002
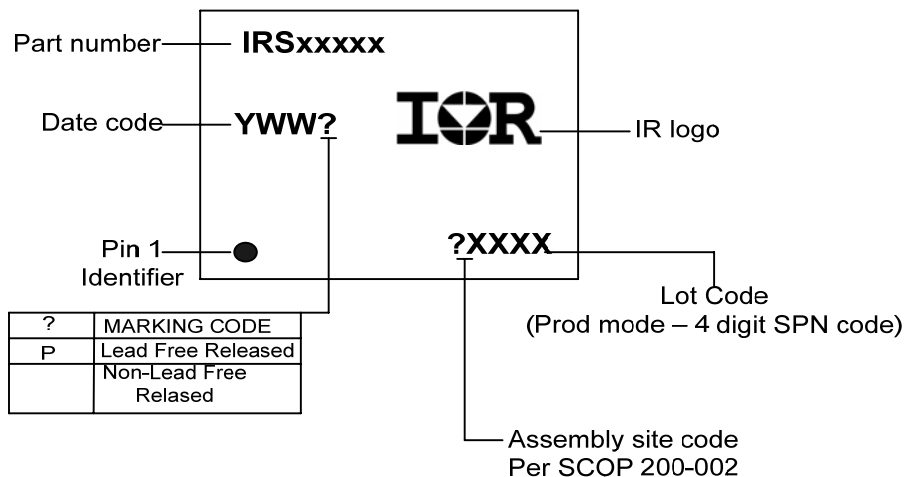
ORDER INFORMATION

8-Lead PDIP IRS2540PbF
8-Lead PDIP IRS2541PbF
8-Lead SOIC IRS22540SPbF
8-Lead SOIC IRS22541SPbF
8-Lead SOIC Tape & Reel IRS2540STRPbF
8-Lead SOIC Tape & Reel IRS2541STRPbF

International **I℞R** Rectifier

The SOIC-8 is MSL2 qualified.
This product has been designed and qualified for the industrial level.
Qualification standards can be found at www.irf.com <http://www.irf.com>
IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, Tel: (310) 252-7105
Data and specifications subject to change without notice 9/7/2006

International **IƆR** Rectifier

IRS254(0,1)(S)PbF

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